PCN Number:	20191103	20191103001 PCN Date: Nov. 6, 2019				9			
Title: Datasheet for AFE030									
Customer Contact	PCN Mana	PCN Manager				Dept:		Quality Services	
Change Type:							•		
Assembly Site			Design				Wafer	Bump Site	
Assembly Process		_	Data Sheet				Wafer Bump Material		
Assembly Materials			Part number change			_	Wafer Bump Process		
Mechanical Specification			Test Site			_	Wafer Fab Site Wafer Fab Materials		
Packing/Shipping/Labeling			Test Process			╡	Wafer Fab Process		
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below.									
The following change history provides further details.									
								AFE030	
TEXAS	•								
INSTRUMENTS SBOS588B – DECEMBER 2011 – REVISED JUNE 2019									
Changes from Revision	A (December 20	11) to R	Revision B					Page	
Deleted Package/Ordering Information table; see Package Option Addendum at the end of the data sheet									
 Deleted ESD specifications from Absolute Maximum Ratings table. Moved to separate ESD Ratings table. Moved content from Application and Implementation 									
Deleted references to Tx PGA calibration in <i>Calibration Modes</i> 41									
Deleted references to Tx PGA calibration in Table 15									
Deleted Packaging/Mechanicals section; information appended to end of data sheet									
The datasheet numb	er will be cha	nging							
Device Family			Change F	rom:		Change To:			
AFE030			SBOS588A			SBOS588B			
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/AFE030									
Reason for Change:									
To accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:	1			<u> </u>					
AFE030AIRGZR	AFE03	OAIRG	ZT						

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN www admin_team@list.ti.com

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.